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#### Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

#### Details

Product Status	Obsolete
Core Processor	eZ8
Core Size	8-Bit
Speed	20MHz
Connectivity	IrDA, UART/USART
Peripherals	Brown-out Detect/Reset, LED, LVD, POR, PWM, WDT
Number of I/O	6
Program Memory Size	4KB (4K x 8)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	8-VDFN Exposed Pad
Supplier Device Package	8-QFN (5x6)
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z8f041aqb020sc

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



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Hardware Overflow         Automatic Powerdown         Single-Shot Conversion         Continuous Conversion         Interrupts         Calibration and Compensation         ADC Compensation Details         Input Buffer Stage         ADC Control Register Definitions         ADC Control Register 1         ADC Control/Status Register 1         ADC Data High Byte Register         ADC Data Low Byte Register	123 123 124 125 125 127 129 130 130 132 132 133
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110 = 64 cycles delay 111 = 128 cycles delay

INPCAP—Input Capture Event

This bit indicates if the most recent timer interrupt is caused by a Timer Input Capture Event.

0 = Previous timer interrupt is not a result of Timer Input Capture Event

1 = Previous timer interrupt is a result of Timer Input Capture Event

#### Timer 0–1 Control Register 1

The Timer 0–1 Control (TxCTL1) registers enable/disable the timers, set the prescaler value, and determine the timer operating mode (Table 49).

Table 49. Timer 0–1 Control Register 1 (TxCTL1)

BITS	7	6	5	4	3	2	1	0
FIELD	TEN	TPOL		PRES		TMODE		
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR				F07H,	F0FH			

TEN-Timer Enable

0 = Timer is disabled.

1 = Timer enabled to count.

TPOL—Timer Input/Output Polarity

Operation of this bit is a function of the current operating mode of the timer.

#### **ONE-SHOT mode**

When the timer is disabled, the Timer Output signal is set to the value of this bit. When the timer is enabled, the Timer Output signal is complemented upon timer Reload.

#### **CONTINUOUS mode**

When the timer is disabled, the Timer Output signal is set to the value of this bit. When the timer is enabled, the Timer Output signal is complemented upon timer Reload.

#### COUNTER mode

If the timer is enabled the Timer Output signal is complemented after timer reload.

0 = Count occurs on the rising edge of the Timer Input signal.

1 = Count occurs on the falling edge of the Timer Input signal.



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BITS	7	6	5	4	3	2	1	0		
FIELD		PWML								
RESET	0	0	0	0	0	0	0	0		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
ADDR				F05H,	F0DH					

#### Table 55. Timer 0–1 PWM Low Byte Register (TxPWML)

PWMH and PWML—Pulse-Width Modulator High and Low Bytes These two bytes, {PWMH[7:0], PWML[7:0]}, form a 16-bit value that is compared to the current 16-bit timer count. When a match occurs, the PWM output changes state. The PWM output value is set by the TPOL bit in the Timer Control Register (TxCTL1) register.

The TxPWMH and TxPWML registers also store the 16-bit captured timer value when operating in CAPTURE or CAPTURE/COMPARE modes.



## Watchdog Timer

The Watchdog Timer (WDT) protects against corrupt or unreliable software, power faults, and other system-level problems which may place the Z8 Encore! XP<sup>®</sup> F082A Series devices into unsuitable operating states. The features of Watchdog Timer include:

- On-chip RC oscillator.
- A selectable time-out response: reset or interrupt.
- 24-bit programmable time-out value.

## Operation

The Watchdog Timer is a one-shot timer that resets or interrupts the Z8 Encore! XP F082A Series devices when the WDT reaches its terminal count. The Watchdog Timer uses a dedicated on-chip RC oscillator as its clock source. The Watchdog Timer operates in only two modes: ON and OFF. Once enabled, it always counts and must be refreshed to prevent a time-out. Perform an enable by executing the WDT instruction or by setting the WDT\_AO Flash Option Bit. The WDT\_AO bit forces the Watchdog Timer to operate immediately upon reset, even if a WDT instruction has not been executed.

The Watchdog Timer is a 24-bit reloadable downcounter that uses three 8-bit registers in the eZ8 CPU register space to set the reload value. The nominal WDT time-out period is described by the following equation:

WDT Time-out Period (ms) =  $\frac{\text{WDT Reload Value}}{10}$ 

where the WDT reload value is the decimal value of the 24-bit value given by {WDTU[7:0], WDTH[7:0], WDTL[7:0]} and the typical Watchdog Timer RC oscillator frequency is 10 kHz. The Watchdog Timer cannot be refreshed after it reaches 000002H. The WDT Reload Value must not be set to values below 000004H. Table 56 provides information about approximate time-out delays for the minimum and maximum WDT reload values.

#### Table 56. Watchdog Timer Approximate Time-Out Delays

WDT Reload Value	WDT Reload Value	Approximate Time-Out Delay (with 10 kHz typical WDT oscillator frequency)				
(Hex)	(Decimal)	Typical	Description			
000004	4	400 μs	Minimum time-out delay			
FFFFF	16,777,215	28 minutes	Maximum time-out delay			

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Driver Enable is an active High signal that envelopes the entire transmitted data frame including parity and Stop bits as displayed in Figure 14. The Driver Enable signal asserts when a byte is written to the UART Transmit Data register. The Driver Enable signal asserts at least one UART bit period and no greater than two UART bit periods before the Start bit is transmitted. This allows a setup time to enable the transceiver. The Driver Enable signal deasserts one system clock period after the final Stop bit is transmitted. This one system clock delay allows both time for data to clear the transceiver before disabling it, as well as the ability to determine if another character follows the current character. In the event of back to back characters (new data must be written to the Transmit Data Register before the previous character is completely transmitted) the DE signal is not deasserted between characters. The DEPOL bit in the UART Control Register 1 sets the polarity of the Driver Enable signal.



#### Figure 14. UART Driver Enable Signal Timing (shown with 1 Stop Bit and Parity)

The Driver Enable to Start bit setup time is calculated as follows:

$$\left(\frac{1}{\text{Baud Rate (Hz)}}\right) \le \text{DE to Start Bit Setup Time (s)} \le \left(\frac{2}{\text{Baud Rate (Hz)}}\right)$$

#### **UART Interrupts**

The UART features separate interrupts for the transmitter and the receiver. In addition, when the UART primary functionality is disabled, the Baud Rate Generator can also function as a basic timer with interrupt capability.

#### **Transmitter Interrupts**

The transmitter generates a single interrupt when the Transmit Data Register Empty bit (TDRE) is set to 1. This indicates that the transmitter is ready to accept new data for transmission. The TDRE interrupt occurs after the Transmit shift register has shifted the first bit of data out. The Transmit Data register can now be written with the next character to

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MPRX—Multiprocessor Receive

Returns the value of the most recent multiprocessor bit received. Reading from the UART Receive Data register resets this bit to 0.

## **UART Transmit Data Register**

Data bytes written to the UART Transmit Data (UxTXD) register (Table 65) are shifted out on the TXDx pin. The Write-only UART Transmit Data register shares a Register File address with the read-only UART Receive Data register.

BITS	7	6	5	4	3	2	1	0
FIELD				Tک	(D			
RESET	Х	Х	Х	Х	Х	Х	Х	Х
R/W	W	W	W	W	W	W	W	W
ADDR				F4	0H			

#### Table 65. UART Transmit Data Register (U0TXD)

TXD-Transmit Data

UART transmitter data byte to be shifted out through the TXDx pin.

### **UART Receive Data Register**

Data bytes received through the RXDx pin are stored in the UART Receive Data (UxRXD) register (Table 66). The read-only UART Receive Data register shares a Register File address with the Write-only UART Transmit Data register.

#### Table 66. UART Receive Data Register (U0RXD)

BITS	7	6	5	4	3	2	1	0	
FIELD	RXD								
RESET	Х	Х	Х	Х	Х	Х	Х	Х	
R/W	R	R	R	R	R	R	R	R	
ADDR	F40H								
X = Undef	X = Undefined.								

RXD—Receive Data

UART receiver data byte from the RXDx pin

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## **UART Address Compare Register**

The UART Address Compare (UxADDR) register stores the multi-node network address of the UART (see Table 67). When the MPMD[1] bit of UART Control Register 0 is set, all incoming address bytes are compared to the value stored in the Address Compare register. Receive interrupts and RDA assertions only occur in the event of a match.

#### Table 67. UART Address Compare Register (U0ADDR)

BITS	7	6	5	4	3	2	1	0
FIELD				COMP	_ADDR			
RESET	0	0	0	0	0	0	0	0
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR				F4	5H			

COMP\_ADDR—Compare Address

This 8-bit value is compared to incoming address bytes.

## UART Baud Rate High and Low Byte Registers

The UART Baud Rate High (UxBRH) and Low Byte (UxBRL) registers (Table 68 and Table 69) combine to create a 16-bit baud rate divisor value (BRG[15:0]) that sets the data transmission rate (baud rate) of the UART.

#### Table 68. UART Baud Rate High Byte Register (U0BRH)

BITS	7	6	5	4	3	2	1	0		
FIELD		BRH								
RESET	1	1	1	1	1	1	1	1		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
ADDR				F4	6H					

#### Table 69. UART Baud Rate Low Byte Register (U0BRL)

BITS	7	6	5	4	3	2	1	0
FIELD				BI	٦L			
RESET	1	1	1	1	1	1	1	1
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR				F4	7H			

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#### ANAIN[3:0]—Analog Input Select

These bits select the analog input for conversion. Not all Port pins in this list are available in all packages for the Z8 Encore! XP<sup>®</sup> F082A Series. For information on port pins available with each package style, see Pin Description on page 9. Do not enable unavailable analog inputs. Usage of these bits changes depending on the buffer mode selected in ADC Control/Status Register 1.

For the reserved values, all input switches are disabled to avoid leakage or other undesirable operation. ADC samples taken with reserved bit settings are undefined.

SINGLE-ENDED:

- 0000 = ANA0 (transimpedance amp output when enabled)
- 0001 = ANA1 (transimpedance amp inverting input)
- 0010 = ANA2 (transimpedance amp non-inverting input)
- 0011 = ANA3
- 0100 = ANA4
- 0101 = ANA5
- 0110 = ANA6
- 0111 = ANA7
- 1000 = Reserved
- 1001 = Reserved
- 1010 = Reserved
- 1011 = Reserved
- 1100 = Hold transimpedance input nodes (ANA1 and ANA2) to ground.
- 1101 = Reserved
- 1110 = Temperature Sensor.
- 1111 = Reserved.

DIFFERENTIAL (non-inverting input and inverting input respectively):

- 0000 = ANA0 and ANA1 0001 = ANA2 and ANA3 0010 = ANA4 and ANA5 0011 = ANA1 and ANA0 0100 = ANA3 and ANA2 0101 = ANA5 and ANA4 0110 = ANA6 and ANA5 0111 = ANA0 and ANA5 1011 = ANA0 and ANA3 1001 = ANA0 and ANA3 1001 = ANA0 and ANA4 1010 = ANA0 and ANA5 1011 = Reserved 1100 = Reserved 1101 = Reserved1101 = Reserved
- 1111 = Manual Offset Calibration Mode

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## Comparator

The Z8 Encore! XP<sup>®</sup> F082A Series devices feature a general purpose comparator that compares two analog input signals. These analog signals may be external stimulus from a pin (CINP and/or CINN) or internally generated signals. Both a programmable voltage reference and the temperature sensor output voltage are available internally. The output is available as an interrupt source or can be routed to an external pin.



Figure 20. Comparator Block Diagram

## Operation

When the positive comparator input exceeds the negative input by more than the specified hysteresis, the output is a logic HIGH. When the negative input exceeds the positive by more than the hysteresis, the output is a logic LOW. Otherwise, the comparator output retains its present value. See Table 137 on page 233 for details.

The comparator may be powered down to reduce supply current. See Power Control Register 0 on page 34 for details.

**Caution:** Because of the propagation delay of the comparator, it is not recommended to enable or reconfigure the comparator without first disabling interrupts and waiting for the comparator output to settle. Doing so can result in spurious interrupts. The following example describes how to safely enable the comparator:

```
di
ld cmp0, r0 ; load some new configuration
nop
```



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## **Temperature Sensor**

The on-chip Temperature Sensor allows you to measure temperature on the die with either the on-board ADC or on-board comparator. This block is factory calibrated for in-circuit software correction. Uncalibrated accuracy is significantly worse, therefore the temperature sensor is not recommended for uncalibrated use.

## **Temperature Sensor Operation**

The on-chip temperature sensor is a Proportional to Absolute Temperature (PTAT) topology. A pair of Flash option bytes contain the calibration data. The temperature sensor can be disabled by a bit in the Power Control Register 0 on page 34 to reduce power consumption.

The temperature sensor can be directly read by the ADC to determine the absolute value of its output. The temperature sensor output is also available as an input to the comparator for threshold type measurement determination. The accuracy of the sensor when used with the comparator is substantially less than when measured by the ADC.

If the temperature sensor is routed to the ADC, the ADC must be configured in unity-gain buffered mode (see Input Buffer Stage on page 129) The value read back from the ADC is a signed number, although it is always positive.

The sensor is factory-trimmed through the ADC using the external 2.0 V reference. Unless the sensor is re-trimmed for use with a different reference, it is most accurate when used with the external 2.0 V reference.

Because this sensor is an on-chip sensor it is recommended that the user account for the difference between ambient and die temperature when inferring ambient temperature conditions.

During normal operation, the die undergoes heating that causes a mismatch between the ambient temperature and that measured by the sensor. For best results, the Z8 Encore! XP<sup>®</sup> device must be placed into STOP mode for sufficient time such that the die and ambient temperatures converge (this time is dependent on the thermal design of the system). The temperature sensor measurement must then be made immediately after recovery from STOP mode.

The following equation defines the transfer function between the temperature sensor output voltage and the die temperature. This is needed for comparator threshold measurements.

 $V = 0.01 \times T + 0.65$ 

where, T is the temperature in °C; V is the sensor output in volts.

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Reserved—Must be 1.

LVD TRIM-Low Voltage Detect Trim

This trimming affects the low voltage detection threshold. Each LSB represents a 50 mV change in the threshold level. Alternatively, the low voltage threshold may be computed from the options bit value by the following equation:

LVD\_LVL =  $3.6 \text{ V} - \text{LVD} \text{TRIM} \times 0.05 \text{ V}$ 

LV	/D Threshold (	(V)
LVD_TRIM	Typical	Description
00000	3.60	Maximum LVD threshold
00001	3.55	
00010	3.50	
00011	3.45	
00100	3.40	
00101	3.35	
00110	3.30	
00111	3.25	
01000	3.20	
01001	3.15	
01010	3.10	Default on Reset
01011	3.05	
01100	3.00	
01101	2.95	
01110	2.90	
01111	2.85	
10000	2.80	
10001	2.75	
10010	2.70	
10011	2.70	
to	to 1.65	Minimum LVD throshold
11111	C0.1	

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WDTCALH—Watchdog Timer Calibration High Byte The WDTCALH and WDTCALL bytes, when loaded into the Watchdog Timer reload registers result in a one second timeout at room temperature and 3.3 V supply voltage. To use the Watchdog Timer calibration, user code must load WDTU with 0x00, WDTH with WDTCALH and WDTL with WDTCALL.

#### Table 98. Watchdog Calibration Low Byte at 007FH (WDTCALL)

BITS	7	6	5	4	3	2	1	0		
FIELD		WDTCALL								
RESET	U	U	U	U	U	U	U	U		
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W		
ADDR	Information Page Memory 007FH									
Note: U =	Unchanged b	v Reset. R/W	= Read/Write	e.						

WDTCALL—Watchdog Timer Calibration Low Byte

The WDTCALH and WDTCALL bytes, when loaded into the Watchdog Timer reload registers result in a one second timeout at room temperature and 3.3 V supply voltage. To use the Watchdog Timer calibration, user code must load WDTU with 0x00, WDTH with WDTCALH and WDTL with WDTCALL.

### **Serialization Data**

#### Table 99. Serial Number at 001C - 001F (S\_NUM)

BITS	7	6	5	4	3	2	1	0
FIELD	S_NUM							
RESET	U	U	U	U	U	U	U	U
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W
ADDR	Information Page Memory 001C-001F							
Note: U = Unchanged by Reset. R/W = Read/Write.								

S NUM—Serial Number Byte

The serial number is a unique four-byte binary value.



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## Assembly Language Syntax

For proper instruction execution, eZ8 CPU assembly language syntax requires that the operands be written as 'destination, source'. After assembly, the object code usually has the operands in the order 'source, destination', but ordering is opcode-dependent. The following instruction examples illustrate the format of some basic assembly instructions and the resulting object code produced by the assembler. This binary format must be followed if manual program coding is preferred or if you intend to implement your own assembler.

**Example 1**: If the contents of Registers 43H and 08H are added and the result is stored in 43H, the assembly syntax and resulting object code is:

#### Table 112. Assembly Language Syntax Example 1

Assembly Language Code	ADD	43H,	08H	(ADD dst, src)
Object Code	04	08	43	(OPC src, dst)

**Example 2**: In general, when an instruction format requires an 8-bit register address, that address can specify any register location in the range 0–255 or, using Escaped Mode Addressing, a Working Register R0–R15. If the contents of Register 43H and Working Register R8 are added and the result is stored in 43H, the assembly syntax and resulting object code is:

#### Table 113. Assembly Language Syntax Example 2

Assembly Language Code	ADD	43H,	R8	(ADD dst, src)
Object Code	04	E8	43	(OPC src, dst)

See the device-specific Product Specification to determine the exact register file range available. The register file size varies, depending on the device type.

## eZ8 CPU Instruction Notation

In the eZ8 CPU Instruction Summary and Description sections, the operands, condition codes, status flags, and address modes are represented by a notational shorthand that is described in Table 114.

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		V <sub>DD</sub> T <sub>A</sub> = (unless	= 3.0 V to 0 °C to + otherwis	3.6 V 70 °C e stated)		Conditions	
Symbol	Parameter	Minimum	Typical	Maximum	Units		
	Single-Shot Conversion Time	-	5129	_	System clock cycles	All measurements but temperature sensor	
			10258			Temperature sensor measurement	
	Continuous Conversion Time	-	256	_	System clock cycles	All measurements but temperature sensor	
			512			Temperature sensor measurement	
	Signal Input Bandwidth	-	10		kHz	As defined by -3 dB point	
R <sub>S</sub>	Analog Source Impedance <sup>4</sup>	-	-	10	kΩ	In unbuffered mode	
				500	kΩ	In buffered modes	
Zin	Input Impedance	-	150		kΩ	In unbuffered mode at 20 $\rm MHz^5$	
		10	_		MΩ	In buffered modes	
Vin	Input Voltage Range	0		V <sub>DD</sub>	V	Unbuffered Mode	
		0.3		V <sub>DD</sub> -1.1	V	Buffered Modes	
					Note:	These values define the range over which the ADC performs within spec; exceeding these values does not cause damage or instability; see DC Characteristics on page 222 for absolute pin voltage limits	

#### Table 135. Analog-to-Digital Converter Electrical Characteristics and Timing (Continued)

#### Notes

- 1. Analog source impedance affects the ADC offset voltage (because of pin leakage) and input settling time.
- 2. Devices are factory calibrated at  $V_{DD}$  = 3.3 V and  $T_A$  = +30 °C, so the ADC is maximally accurate under these conditions.
- 3. LSBs are defined assuming 10-bit resolution.
- 4. This is the maximum recommended resistance seen by the ADC input pin.
- 5. The input impedance is inversely proportional to the system clock frequency.



		V <sub>DD</sub> = 2.7 V to 3.6 V T <sub>A</sub> = -40 °C to +105 °C					
Symbol	Parameter	Minimum	Typical	Maximum	Units	Conditions	
Av	Open loop voltage gain		80		dB		
GBW	Gain/Bandwidth product		500		kHz		
PM	Phase Margin		50		deg	Assuming 13 pF load capacitance	
V <sub>osLPO</sub>	Input Offset Voltage		<u>+</u> 1	<u>+</u> 4	mV		
V <sub>osLPO</sub>	Input Offset Voltage (Temperature Drift)		1	10	μV/C		
V <sub>IN</sub>	Input Voltage Range	0.3		Vdd - 1	V		
V <sub>OUT</sub>	Output Voltage Range	0.3		Vdd - 1	V	I <sub>OUT</sub> = 45 μA	

#### Table 136. Low Power Operational Amplifier Electrical Characteristics

### Table 137. Comparator Electrical Characteristics

		V <sub>DD</sub> T <sub>A</sub> = -	V <sub>DD</sub> = 2.7 V to 3.6 V T <sub>A</sub> = -40 °C to +105 °C			
Symbol	Parameter	Minimum	Typical	Maximum	Units	Conditions
V <sub>OS</sub>	Input DC Offset		5		mV	
V <sub>CREF</sub>	Programmable Internal Reference Voltage		<u>+</u> 5		%	20-/28-pin devices
			<u>+</u> 3		%	8-pin devices
T <sub>PROP</sub>	Propagation Delay		200		ns	
V <sub>HYS</sub>	Input Hysteresis		4		mV	
V <sub>IN</sub>	Input Voltage Range	V <sub>SS</sub>		V <sub>DD</sub> -1	V	

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Figure 38 and Table 143 provide timing information for UART pins for the case where CTS is not used for flow control. DE asserts after the transmit data register has been written. DE remains asserted for multiple characters as long as the transmit data register is written with the next character before the current character has completed.



Figure 38. UART Timing Without CTS

Table 143. UAR	Timing	Without	CTS
----------------	--------	---------	-----

		Delay (ns)			
Parameter	Abbreviation	Minimum	Maximum		
UART					
T <sub>1</sub>	DE assertion to TXD falling edge (start bit) delay	1 * XIN period	1 bit time		
T <sub>2</sub>	End of Stop Bit(s) to DE deassertion delay (Tx data register is empty)	± 5			





Figure 44 displays the 20-pin Small Shrink Outline Package (SSOP) available for the Z8 Encore! XP F082A Series devices.

Figure 44. 20-Pin Small Shrink Outline Package (SSOP)



## **Customer Support**

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